

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

MS Patent Application
 Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450

Re: Inventor: Judon Tony PAN
 Title: BOND PAD TECHNIQUES FOR INTEGRATED CIRCUITS

17059 U.S. PRO
 10/654240
 09/02/03

Transmitted herewith is the patent application identified above, including:

- Specification, claims and abstract, totaling 39 pages.
- Drawings totaling 13 pages, Formal Informal.
- Executed Declaration and Power of Attorney.
- Assignment of the invention to Applied Materials, Inc.
- Assignment Recordation Cover Sheet

FEE CALCULATION					
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	40	- 20 =	20	X \$18.00	\$360.00
Independent Claims	11	- 3 =	8	X \$18.00	\$672.00
Basic Filing Fee				\$750.00	\$750.00
TOTAL FEES					\$1,782.00

- The Commissioner is hereby authorized to charge \$1,782.00 to Deposit Account No. 50-1074.
- The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1074. A duplicate copy of this transmittal is enclosed.
- Please address all future correspondence to:

PATENT COUNSEL
 APPLIED MATERIALS, INC.
 Legal Affairs Department
 P.O.BOX 450A
 Santa Clara, CA. 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: MS Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Express Mail Receipt No. EV341102164S

Date of Deposit SEPT. 2, 2003

Signature Emmanuel

Respectfully submitted,

Robert W. Mulcahy
 Registration No. 25,436